TECHNICAL INSIGHTS

ADVANCED · MANUFACTURING

01st May 2015

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1. REDUCING HAND TOOL NOISE AND VIBRATION

Even veteran craft workers have experienced unwanted vibrations and noise while employing hand-held power tools. Researchers at the Fraunhofer Institute for Structural Durability and System Reliability LBF in Darmstadt, Germany; and C & E. Fein GmbH in Schwäbisch Gmünd-Bargau, Germany, joined forces to develop the MultiMaster oscillator that reduces vibration by 70% and noise by 50% in hand-held power tools.

The Fraunhofer Institute is part of Fraunhofer-Gesellschaft, Europe's largest applied research entity, and employs nearly 24,000 people who use an annual research budget of over ϵ 2 billion (about \$2.2 billion at the current exchange rate). Approximately ϵ 1.7 billion (about \$1.9 billion at the current exchange rate), or over 70%, of this is derived from industry contracts such as the contract to develop the MultiMaster oscillator.

Wilhelm Emil Fein founded C & E. Fein GmbH to manufacture electrical and physical equipment in 1867. His son, Emil, made history with the invention of the first electric hand drill in 1895. Over the years, the Stuttgart-based company added power tools to its portfolio, including electric screwdrivers and grinders. C & E Fein employs about 900 people globally, and holds 500 patents and patent applications that make it one of the world's leading developers of power tools.

According to Heiko Atzrodt, a group manager at Fraunhofer LBF, the joint design team examined power tools to devise a new technology that could be adapted to oscillating power tools. Rather than using a rotary action, the MultiMaster moves the tool back and forth at nearly 19,500 times per minute to cut, file, polish, rasp, saw, sand, shave, sever, and sharpen. This includes performing these actions in places that are difficult to reach.

The key to dampening vibration of the rapid backward and forward motion of the tool was to decouple the new oscillator's housing from the motor by means of elastomer elements. These flexible elements mechanically suspend and insulate the oscillator's components so that only a fraction of the motor's vibrations will be transferred to the housing and, thus, the tool's user. An important consideration of the inventors was not to over-design the insulation so that the craft worker would not be able to feel how hard he or she is pressing the onto their work piece. The German designers had to balance the minimization of vibration while retaining the desired feel of what their tool is doing .

The scientists achieved this balance by regulating the stiffness provided by the elastomer elements. They employed simulation modeling to discover what would be the optimal range of stiffness, and used that to design and integrate different suspension and insulating devices into their test systems. Testing provided the team with basic development parameters for their power tool oscillator.

The anti-vibration system enabled C & E Fein to reduce power tool vibration to less than one-third of previous generation power tools. This also helps tool users who work shifts, such as automobile craft workers, to use the tool for their entire eight-hour shift, improving productivity. In addition, the insulating properties of the elastomer elements halves the acoustic pressure compared to standard power tools.

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2. ENHANCEMENTS IN 3D SENSING

Three-dimensional (3D) imaging sensors usually operate by projecting (in the active form) or acquiring (in the passive form) electromagnetic energy onto or from an object followed by recording the transmitted or reflected energy. In reflection optical sensing, light carries the measurement information. There are various techniques for 3D reflection optical depth sensing, including structured light (which projects patterns of non-coherent light, and elaborates them to obtain the range information for each viewed point simultaneously) and time of flight (an emitter generates a laser pulse, which impinges the target surface, a receiver detects the reflected pulse, and electronics can measure the round-trip travel time and intensity of the returning signal). In 3D depth sensors based on time of flight, each pixel can measure the time the light has taken to travel from the illumination unit (laser or LED) to the object and back to the image sensor.

The 3D depth sensing technology used in the original Microsoft's Kinect motion sensing input devices for Xbox video game consoles used structured light to project a pattern of light onto a 3D scene and infer or compute depth and the 3D structure from the deformation or distortion of that light pattern. A later version of Kinect has used time-of-flight sensing consisting of an infrared laser projector combined with a monochrome CMOS (complementary metal oxide semiconductor) sensor, which captures video data in 3D.

Time-of-flight imaging can provide advantages such as the need for only one specific camera; no manual depth computation required; acquisition of 3D scene geometry in real-time; reduced dependence on scene illumination; virtually no dependence on scene texturing. However, limitations in time-of-flight imaging can include low pixel resolution; individual pixels obtain different depth measurements; depth in homogeneity; light interference effects (for example, the emitted light can be attenuated and scattered in the scene); interference from other sources of near infrared light, such as sunlight.

Supported by the Office of Naval Research and the US Department of Energy, a team of researchers at Northwestern University and Columbia University, led by Oliver Cossairt, assistant professor of electrical engineering and computer science at Northwestern University's McCormick School of Engineering, have developed a 3D camera. The researchers noted that Kinect technology has had limitations, such as inability to work outdoors and relatively low-quality images. The 3D camera addresses these challenges. The camera uses single-point 3D scanning to be able to generate high-quality images in varied environments, including outdoors.

The researchers indicated that the first and second generation Kinect devices are less precise than expensive single-point scanners, which use a laser to scan points across an entire scene or object. The team's camera uses singlepoint scanning differently; it only scans parts of the scenes that have changed, providing faster imaging and higher quality.

The researchers also mentioned that, in the Kinect, sunlight can overpowers its projected light patterns. However, the laser on developed camera can be sensed in the presence of the sun since it is much brighter than ambient light.

Applications for the 3D camera with innovative, low-power 3D single-point scanning include those in which 3D shapes of scenes need to be captured in the wild, such as robotics, bioinformatics, augmented reality, and manufacturing automation. Another potential application is navigation, including automobile or wheelchair navigation.

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3. NANOSCALE TUNGSTEN STUDY COULD PROVIDE VALUABLE DATA ON MAKING STRONGER METALS

The development of nanomaterials, whose grain sizes are on the nanometer, or billionth of a meter, scale, holds great potential in computers, electronics, medicine, tooling, and other applications. This is because nanomaterials can have novel desirable properties (for example, optical, conductive, or antibacterial properties) previous generation materials do not. However, even their most ardent supporters acknowledge that much more fundamental research needs to be done to deploy nanomaterials widely in science and industry.

Academic researchers at the Georgia Institute of Technology in Atlanta, Georgia; the University of Pittsburgh in Pittsburgh, Pennsylvania; and Drexel University in Philadelphia, Pennsylvania; have teamed up to investigate the atomic-scale deformation mechanisms in body-centered cubic (BCC) tungsten nanocrystals. The resulting structure in turn determines the function of strength of nanomaterials.

The Georgia Institute of Technology, better known as Georgia Tech, is a public research university founded in 1885 to help foster industry in Georgia in the wake of the US Civil War. In the fall of 2014, Georgia Tech reported an endowment of \$1.88 billion to support its six colleges, comprising approximately 31 departments or units. Founded in 1787 as the Pittsburgh Academy at the then Western frontier of the United States, the state-related research university listed a 2014 endowment of \$3.49 billion. Pittsburgh University spends approximately \$900 billion on research and development annually, rivaling major corporations. Drexel University dates back to 1891 as a private research university that now employs approximately 2,400 faculty, who teach more than 26,000 undergraduate, graduate, and doctoral students. Drexel reported a \$650 million endowment in 2014.

The academic scientists combined a high-resolution transmission electron microscope (TEM), with advanced computer modeling to conduct their atomic scale deformation twinning investigation. Deformation twinning refers to deforming a material with dislocation slip to permanently change its shape without breaking it. During twinning, the crystal in a material's structure will reorient. This forms a region that reflect the original image of the crystal. The twinning phenomenon has been created in large scale BCC metals and alloys when they are deformed, but researchers had not reported observing it in nanoscale materials.

The Georgia Tech, Pittsburgh, and Drexel team selected tungsten for their research as a typical BCC crystal, and its ubiquitous use, such as light bulb filaments. Scott Mao, a professor in the Swanson School of Engineering at the University of Pittsburgh and Jiangwei Wang, a graduate student at that university, found a way to weld two pieces of nanoscale tungsten crystal to create a wire approximately 20 nanometer in diameter under a TEM. Wang stretched and compressed the wire while observing twinning using the TEM.

The assistant professor in Drexel University's College of Engineering, augmented the twinning experiment by developing computer models that depict the mechanical behavior of the tungsten nanostructure at an atomic level. Weinberger's modeling enabled the research team to observe the physical factors that occur during twinning. Scientists can use this information to develop theories for why twinning occurs in nanoscale tungsten. In addition, the modeling data can help researchers create ways to study this behavior in other BCC materials.

Ting Zhu, associate professor at the Woodruff School of Mechanical Engineering at Georgia Tech, and his graduate student colleague Zhi Zeng, used molecular dynamics to perform sophisticated computer simulations for investigating the deformation of nanoscale tungsten in 3D. An interesting finding of the duo is that when tungsten is reduced to the nanoscale, its strength actually increases by several orders of magnitude, while ductility decreases dramatically. The challenge for materials scientists is to increase tungsten's strength while maintaining its ductility. Research into how to control deformation mechanisms will help scientists achieve that goal.

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4. PATENT ANALYSIS OF SAND CASTING PROCESS

Sand casting, which casts metals using sand as the mold material, is a most widely used casting process for metals. A wide range of metals can be molded using sand casting. This process is employed in creating a range of metal castings in various sizes, such as small machine tool heads to huge engine blocks, valves, and so on.

Normally, two types of sand are used in this process--natural sand and synthetic sand. Natural sand has the disadvantage of natural impurities while synthetic sand can be made with properties for creating castings of desired characteristics.

Over the years, the sand casting process has become customized and new methods and materials have been included to produce castings with complex geometries. Also, many new processes to remove the sand accumulation on intricate casting structures have been devised.

Exhibit 1 shows the recent patents for the sand casting process. The patent assigned to Hitachi Metals (WO/2015/054252) pertains to a sand casting mold manufacturing process for manufacturing cast iron objects. A patent assigned to Gen Gen Electric (December 31, 2014/EU 2817113) pertains to explains a system and method for electromagnetically stirring sand castings.

Other patents point to innovations in cleaning the metal objects after casting in sand, such as the patent assigned to Chaoyang Jiacheng Refractories Co., Ltd. (August 20, 2014/China 103990764), which pertains to a method for casting sand core repairing paste; and a patent and a patent assigned Changshu Qinfeng Casting Factory (July 30, 2014/China), which refers to a sand cleaning machine connecting block.

Interestingly, many patents for the sand casting process have been filed from the APAC region, particularly from China.

Exhibit 1 depicts patents related to Sand casting process.

Picture credit : WIPO Patentscope

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